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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): Execution Date

1) Fay Hua, 1) September 1, 2004,
2) Thomas J. Fitzgerald, 2) September 3, 2004,
3) Carl L. Deppisch, 3) September 2, 2004,
4) Gregory M. Chrysler 4) September 2, 2004

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Intel Corporation
2200 Mission College Blvd., Santa Clara, CA 95052

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s): **10/871,978, filed June 18, 2004**

B. Patent No.(s): _____

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

David W. Victor
KONRAD RAYNES & VICTOR, LLP
315 S. Beverly Drive, Suite 210
Beverly Hills, CA 90212

6. Total number of applications and patents involved: [1]

7. Total fee (37 CFR 3.41).....\$ 40

- ☒ Enclosed; Credit Card Authorization Form
☐ Authorized to be charged to deposit account

8. Deposit account number: 50-0585

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

David W. Victor
Name of Person Signing

Signature

October 15, 2004
Date

Total number of pages including cover sheet, credit card authorization form and executed assignments: [6]

OMB No. 0651-0011 (exp. 4/94)

CERTIFICATE UNDER 37 CFR 1.8:

I hereby certify that this correspondence is being transmitted by facsimile to Assignment Recordation Services of the U.S. Patent and Trademark Office at 703-306-5995, or being deposited with the United States Postal Service with sufficient postage for first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box Alexandria, VA 22313-1450 on October 15, 2004.

Geoffrey Bell
Geoffrey Bell

10/15/04
Date

OP \$40.00 10871978

700123521

PATENT
REEL: 015252 FRAME: 0501

0077.0079

ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

(1) Fay Hua

of San Jose
and State of California

(2) Thomas J. Fitzgerald

of Phoenix
and State of Arizona

(3) Carl L. Deppisch

of Chandler
and State of Arizona

(4) Gregory M. Chrysler

of Chandler
and State of Arizona

have invented certain improvement in

TITLE ELECTRONIC ASSEMBLY HAVING AN INDIUM WETTING LAYER ON A THERMALLY CONDUCTIVE
BODY

SERIAL NO. 10/871,978

FILING DATE June 18, 2004

DATES THAT INVENTORS SIGNED THE DECLARATION and executed, respectively, a United States patent application therefore on
(1) 9/1/04, 2004, (2) _____, 2004, (3) _____, 2004, and (4) _____, 2004

Whereas, INTEL CORPORATION, a corporation of Delaware, having a place of business at 2200 Mission College Blvd., Santa Clara, CA 95052. (hereinafter called INTEL CORPORATION), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to INTEL CORPORATION, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to INTEL CORPORATION, its successors and assigns, and I hereby agree that INTEL CORPORATION may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by INTEL CORPORATION.

Signed and sealed

CITY
DATE(1) at Santa Clara
on Sept. 1, 2004,
Fay HuaSIGNATURE
INVENTORCITY
DATE(2) at _____
on _____, 2004,

Thomas J. Fitzgerald

SIGNATURE
INVENTOR

0077.0079

CITY (3) at _____ SIGNATURE
DATE on _____, 2004, Carl L. Deppisch INVENTOR

CITY (4) at _____ SIGNATURE
DATE on _____, 2004, Gregory M. Chrysler INVENTOR

0077.0079

ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

(1) Fay Hua

(2) Thomas J. Fitzgerald

(3) Carl L. Deppisch

(4) Gregory M. Chrysler

of San Jose
and State of California
of Phoenix
and State of Arizona
of Chandler
and State of Arizona
of Chandler
and State of Arizona

have invented certain improvement in

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Signed and sealed

CITY
DATE(1) at _____
on _____, 2004,

Fay Hua

SIGNATURE
INVENTORCITY
DATE(2) at Chandler, AZ
on 3rd Sept, 2004,

Thomas J. Fitzgerald

SIGNATURE
INVENTOR

Page 1 of 2

PATENT

REEL: 015252 FRAME: 0504

TOTAL P.06

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CITY (3) at Chandler, AZ
DATE on September 2, 2004,

Carl L. Deppisch
Carl L. Deppisch SIGNATURE INVENTOR

CITY (4) at Chandler, AZ
DATE on 2 Sept, 2004,

Gregory M. Chrysler
Gregory M. Chrysler SIGNATURE INVENTOR